

<b>PATENT ASSIGNMENT COVER SHEET</b>
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EPAS ID: PAT4011665

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JAMES WANG	08/09/2016
CHAK-MING CHIE	08/15/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	TUBIS TECHNOLOGY INC
<b>Street Address:</b>	150 SOUTH LOS ROBLES AVE
<b>Internal Address:</b>	SUITE 830
<b>City:</b>	PASADENA
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	91101
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	13959542
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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<b>ATTORNEY DOCKET NUMBER:</b>	T-PTNTR201330
<b>NAME OF SUBMITTER:</b>	PETER G.H. HWANG
<b>SIGNATURE:</b>	/PETER GH HWANG 50265/
<b>DATE SIGNED:</b>	08/17/2016
<b>Total Attachments: 1</b>	
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**ASSIGNMENT OF PATENT APPLICATION**

WHEREAS, we, James June-Ming Wang, Chak-Ming Chie, .... (hereinafter referred to as ASSIGNORS), having post office addresses of:

1473 Waverly Rd, San Marino, CA 91108, U.S.A.;  
10622 Youngworth Road, Culver City, CA 90230, U.S.A.; 7-114

...

respectively, are the joint inventors of the invention described and claimed in the specification forming part of the United States patent application entitled "Hierarchically Elaborated Phased-Array Antenna Modules and Method of Operation." 13959542 filed 08-05-2013;

WHEREAS, Tubis Technology Inc., a corporation organized under the laws of Delaware and having a place of business at No. 150 South Los Robles Ave., Suite 830, Pasadena, CA 91108, U.S.A. (hereafter referred to as ASSIGNEE) are desirous of acquiring the entire right, title, and interest in and to the invention and in and to any letters patents that may be granted thereof in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign, and transfer unto ASSIGNEE, the entire right, title, and interest in and to said invention, said application and any and all letters patents which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty, or otherwise, said invention, application and all letters patents on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors an assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer, and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patents on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patents on said invention, for litigation regarding said letters patents, or for the purpose of protecting title to said invention or letters patents therefor.

IN WITNESS WHEREOF, We have hereunto signed our names on the day and year set forth below.

James Wang  
Inventor's Signature

James June-Ming Wang  
Inventor's Printed Name

08/09/16  
Date

Chak-Ming Chie  
Inventor's Signature

Chak-Ming Chie  
Inventor's Printed Name

08/15/16  
Date

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Inventor's Signature

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